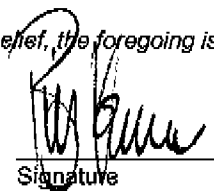


Attorney Docket No. CPAC 1017-3

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| FORM PTO-1595 (Rev. 6-93) | Recordation Form Cover Sheet (Patents Only) | U.S. Department of Commerce Patent and Trademark Office |
| To the Honorable Asst. Commissioner for Patents. Please record the attached original documents or copy thereof | | |
| 1. Name of conveying party(ies): Marcos Kamezos Additional name(s) of conveying parties attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No. | 2. Name and address of receiving party(ies) ChipPAC, Inc. 47400 Kato Road Fremont, CA 94538 | |
| 3. Nature of conveyance: <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Other: Execution Dates: 21 November 2003 | | |
| 4. Application Number(s) or Patent Numbers. If this document is being filed together with a new application, the execution date of the application is: A. Patent Application No(s): 60/411,590 and 10/632,568 B. Patent No(s): Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No | | |
| 5. Name and address of party to whom correspondence concerning document should be mailed: Name: Bill Kennedy HAYNES & BEFFEL LLP P.O. Box 366 Half Moon Bay, California 94019 (650) 712-0340 | 6. Total number of applications and patents involved 2 7. Total fee (37 CFR 3.41): \$80.00 <input type="checkbox"/> Enclosed <input checked="" type="checkbox"/> Charge Fees to Deposit Account <input checked="" type="checkbox"/> Charge any additional fees associated with this paper or during the pendency of this application, or credit any overpayment, to deposit account. | |
| 8. Deposit account number: 50-0869 (CPAC 1017-3) | | |
| DO NOT USE THIS SPACE | | |
| 9. Statement and signature. <i>To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true of copy of the original document.</i> <div style="display: flex; justify-content: space-between; align-items: flex-end;"> <div style="width: 30%;"> Bill Kennedy Name of Person Signing Atty Reg. No. 33,407 </div> <div style="width: 30%; text-align: center;">  Signature </div> <div style="width: 30%; text-align: right;"> Rg. No. 33,407 18 December 2003 Date </div> </div> <p style="text-align: right; margin-top: 10px;">Total number of pages including cover sheet, attachments and document</p> | | |
| 10. Change Correspondence Address to that of Part 5? <input type="checkbox"/> Yes <input type="checkbox"/> No | | |
| OMB No. 0651-0011 (exp. 4/94) | | |
| Do not detach this portion Mail documents to be recorded with required cover to: Mail Stop: Assignments Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 | | |

CH \$80.00 600869 60411590

Atty. Docket No. CPAC 1017-3

**SOLE TO CORPORATE
ASSIGNMENT**

WHEREAS, the undersigned Marcos Karnezos, hereinafter termed the "Inventor" has invented certain new and useful improvements in:

**SEMICONDUCTOR MULTI-PACKAGE MODULE HAVING PACKAGE STACKED
OVER BALL GRID ARRAY PACKAGE AND HAVING WIRE BOND INTERCONNECT
BETWEEN STACKED PACKAGES**

and has filed a provisional application for United States patent disclosing and identifying the invention, the said provisional application having been filed on September 17, 2002 as U.S. Application No. 60/411,590; and has filed a non-provisional application for United States patent disclosing and identifying the above invention, the non-provisional application having been filed on August 2, 2003 as U.S. Application No. 10/632,568, OR is filing such a non-provisional application herewith; and has executed an oath or declaration of inventorship for such non-provisional application on:

the 21 day of November, 2003,

hereinafter termed the "Applications"; and

WHEREAS, ChipPAC, Inc., a corporation of the state of Delaware, having a place of business at 47400 Kato Road, Fremont, California 94538 (hereinafter termed the "Assignee") is desirous of acquiring the entire right, title and interest in and to the Applications and the invention disclosed therein, and in and to any and all embodiments of the invention, heretofore conceived, made, or discovered jointly or severally by said Inventor (all collectively hereinafter termed the "Invention") and in and to any and all patents, inventors' certificates, and other forms of protection (hereinafter termed the "Patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged by the Inventor:

1. The Inventor has assigned to the Assignee, and does hereby sell, assign, transfer and convey to the Assignee all right, title and interest (a) in and to the Invention and the Application; and (b) in and to all rights to apply for foreign patents (including patent, utility model and industrial designs) on the Invention pursuant to the International Convention for the Protection of Industrial Property or otherwise, including the right to claim priority from the Application; and (c) in and to any and all applications filed and any and all patents granted on the Invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extension of any of said patents.

2. The Inventor hereby covenants and agrees to cooperate with the Assignee to enable the Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by the Inventor shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by the Assignee (a) for perfecting in the Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering the Invention; (d) for filing and prosecuting applications for reissuance of any said Patents; (e) for interference or other priority proceedings involving the Invention; and (f) for legal proceedings involving the Invention and any applications therefor and any patents granted thereon, including without limitation reissues and

PATENT**REEL: 014207 FRAME: 0519**


Atty. Docket No. CPAC 1017-3

reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by the Inventor in providing such cooperation shall be paid for by the Assignee.

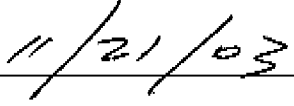
3. The terms and covenants of this assignment shall inure to the benefit of the Assignee, its successors, assigns and other legal representatives, and shall be binding upon the Inventor, his heirs, legal representatives and assigns.

4. The Inventor hereby warrants and represents that he has not entered into and will not enter into any assignment, contract, or understanding in conflict herewith.

IN TESTIMONY WHEREOF, the Inventor has executed and delivered this instrument to the Assignee as of the date written below.



Marcos Kafnezos



Date